

STPS60L30C-Y

Automotive power Schottky rectifier

Features

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- AEC-Q101 qualified

Description

60 A dual center tab Schottky rectifier suitable for automotive applications.

Packaged in PowerSO-20 (slug up), this device is especially intended for use in a low voltage applications.

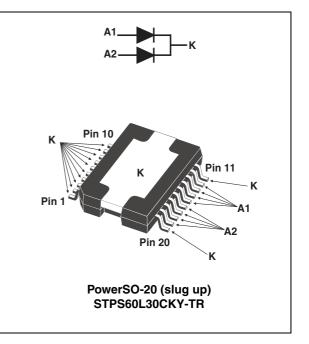


Table 1. Device summary

Symbol	Value
I _{F(AV)}	2 x 30 A
V _{RRM}	30 V
T _{j(max)}	150 °C
V _{F(max)}	0.415 V

Characteristics 1

	meter			Value	Unit				
Repetitive peak reverse voltage									
	•	Repetitive peak reverse voltage						30	V
Forward rms current				45	А				
Average forward current	$ \begin{array}{ll} T_c = & 130 \ ^\circ C, \ \delta = 0.5 \\ Square \ pulse \end{array} \begin{array}{ll} \mbox{Per diode} \\ \mbox{Per device} \end{array} $			30 60	A				
Surge non repetitive forward current $t_p = 10 \text{ ms Sinusoidal}$				250	А				
Storage temperature range				-65 to +175	°C				
Operating junction temperature range -40				-40 to +150	°C				
Recommended reflow soldering temperature range245 +0/-5				°C					
	Average forward current Surge non repetitive forward cu Storage temperature range Operating junction temperature	Average forward current $T_c = 130$ Square pSurge non repetitive forward currentStorage temperature rangeOperating junction temperature range	Average forward current $T_c = 130 \ ^{\circ}C, \ \delta = 0.5$ Square pulseSurge non repetitive forward current $t_p = 10 \ \text{ms}$ Storage temperature rangeOperating junction temperature range	Average forward current $T_c = 130 \degree C, \delta = 0.5$ Square pulsePer diode Per deviceSurge non repetitive forward current $t_p = 10 \mbox{ ms Sinusoidal}$ Storage temperature rangeOperating junction temperature range	Average forward current $T_c = 130 \circ C, \delta = 0.5$ Square pulsePer diode Per device30 60Surge non repetitive forward current $t_p = 10 \text{ ms Sinusoidal}$ 250Storage temperature range-65 to +175Operating junction temperature range-40 to +150				

Table 2. Absolute rating (limiting value, per diode)

1. All anode pins (A1, A2) must be connected

Table 3. **Thermal parameters**

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	0.95 0.61	°C/W
R _{th(c)}	Coupling	0.27	°C/W

When diodes 1 and 2 are used simultaneously:

 $\Delta T_{j(diode 1)} = P_{(diode 1)} \times R_{th(j-c)(Per diode)} + P_{(diode 2)} \times R_{th(c)}$

Static electrical characteristics (per diode) Table 4.

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}			2	mA	
	T _j = 125 °C	VR − VRRM			400	mA	
V _F ^{(1) (2)} Forward voltage drop	$T_j = 25 \ ^{\circ}C$	I _F = 10 A			0.420		
	T _j = 125 °C	I _F = 10 A			0.310	V	
	Forward voltage drop	T _j = 25 °C	I _F = 30 A			0.490	v
		T _j = 125 °C	I _F = 30 A			0.415	

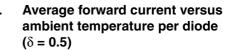
1. Pulse test : $t_p = 380 \ \mu s, \ \delta < 2\%$

2. All anode pins (A1, A2) must be connected

To evaluate the maximum conduction losses use the following equation: P = 0.315 x $I_{F(AV)}$ + 0.00333 x ${I_F}^2_{(RMS)}$



Figure 1. Average forward power dissipation Figure 2. versus average forward current



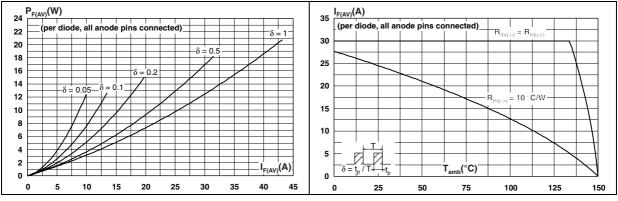
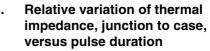


Figure 3. Non repetetive surge peak forward Figure 4. current versus overload duration (maximum values)



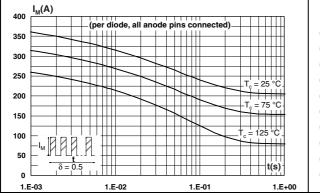


Figure 5. Reverse leakage current versus I reverse voltage applied (per diode) (typical values)

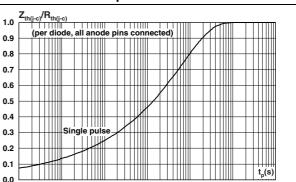


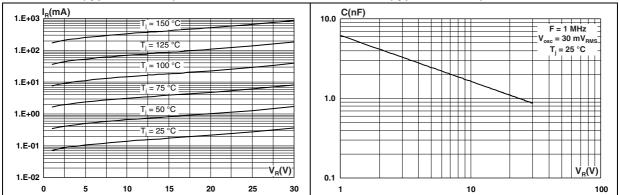
Figure 6. Junction capacitance versus reverse voltage applied (per diode) (typical values)

1.E-02

1.E-01

1.E+00

1.E+01



1.E-05

1.E-04

1.E-03

$\begin{array}{c c} \mathbf{I}_{FM}(\mathbf{A}) \\ \hline (\text{per diode, all anode pins connected}) \\ \hline 50 \\ \hline \end{array}$
$\begin{array}{c c c c c c c c c c c c c c c c c c c $
(Maximum values)
40 T _j = 125 °C (Typical values)
30
20
10 T _j = 25 °C (Maximum values)
0 V _{FM} (V)
0.00 0.05 0.10 0.15 0.20 0.25 0.30 0.35 0.40 0.45 0.50 0.55 0.60

Figure 7. Forward voltage drop versus forward current



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 5. Fower 50-20 (slug		Dimensions					
	Ref	r	Aillimete	er		Inch	
		Min.	Тур.	Max.	Min.	Тур.	Max.
	А	3.25		3.5	0.128		0.138
	A2	3	3.15	3.3	0.118	0.124	0.13
	A4	0.8		1	0.031		0.039
0 PLANAR	A5	0.15	0.2	0.25	0.006	0.008	0.01
	a1	0.03		-0.04	0.0012		-0.0016
	b	0.4		0.53	0.016		0.021
	С	0.23		0.32	0.009		0.012
	D ⁽¹⁾	15.8		16	0.622		0.63
	J D1	9.4		9.8	0.37		0.385
) DETAILA	D2		1			0.039	
	E	13.9		14.5	0.547		0.57
	E1 ⁽¹⁾	10.9		11.1	0.429		0.437
	E2			2.9			0.114
	E3	5.8		6.2	0.228		0.244
	• e	1.12	1.27	1.42	0.044	0.05	0.056
	e3		11.43			0.45	
	G	0		0.1	0		0.004
	Н	15.5		15.9	0.61		0.625
	h			1.1			0.043
	L	0.8		1.1	0.031		0.043
	N			10°			10°
	R		0.6			0.024	
	S	0°		8°	0°		8°
	V	5°		7°	5°		7°

Table 5. PowerSO-20 (slug up) dimensions

1. These measurements do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm (0.006"). Critical dimensions: E, a1, e, and G.



3 Ordering information

Table 6.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS60L30CKY-TR	PS60L30CY	PowerSO-20	1.93 g	600	Tape and reel

4 Revision history

Table 7.Document revision history

Date	Revision	Changes
02-Dec-2010	1	First issue.



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